SSL MANUFACTURING: A DECADE OF CHANGE

DOE LIGHTING R&D PROGRAM



Where Were We a Decade Ago?





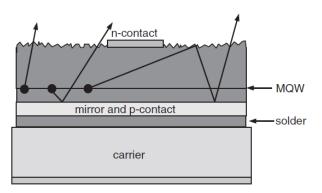




LED Lighting = High-power LEDs in 2010

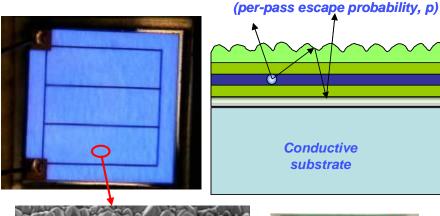


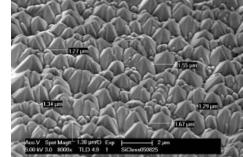
ThinGaN - OSRAM





EZBright - Cree



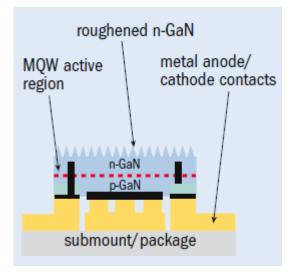


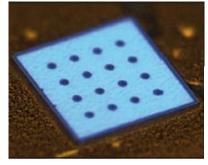


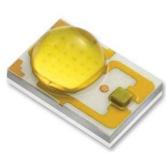
Surface texture

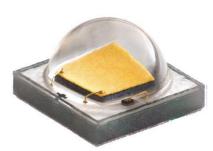
Warm White (3000 K) \sim 90 LPW Cool White (6000 K) \sim 120 LPW

TFFC - Lumileds









Evolution of Substrates



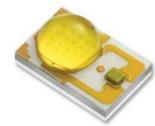




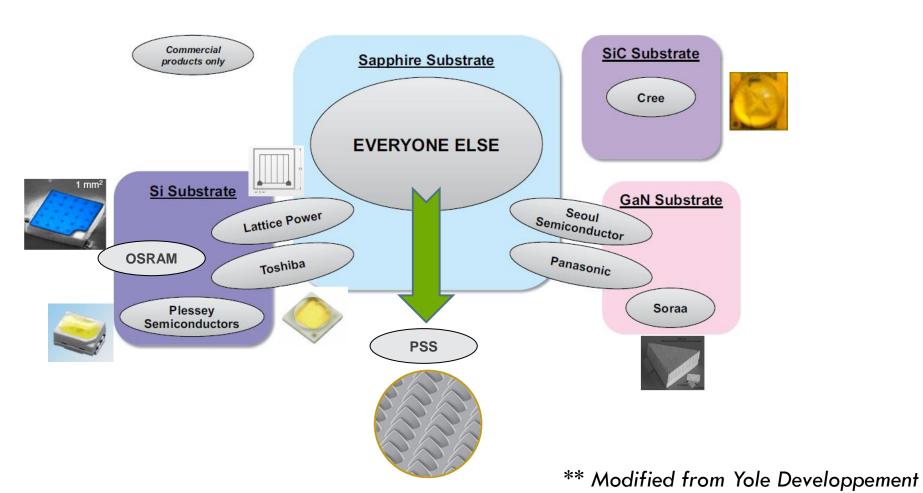


Sapphire





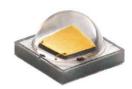
2014 Status



2015: Chip Designs

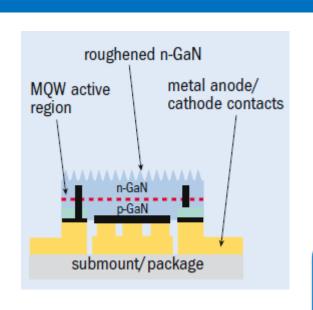


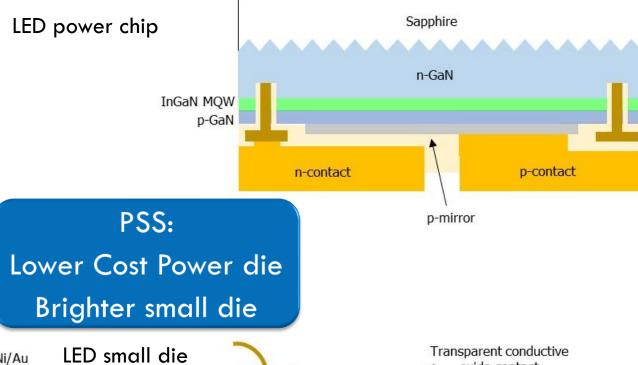


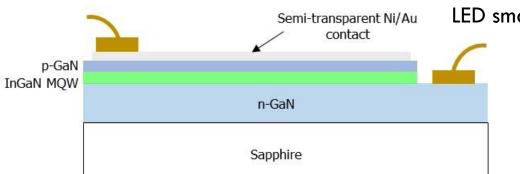


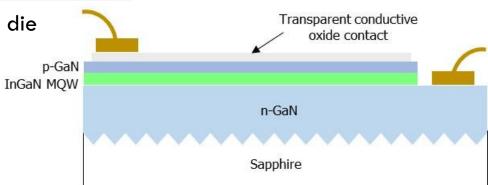






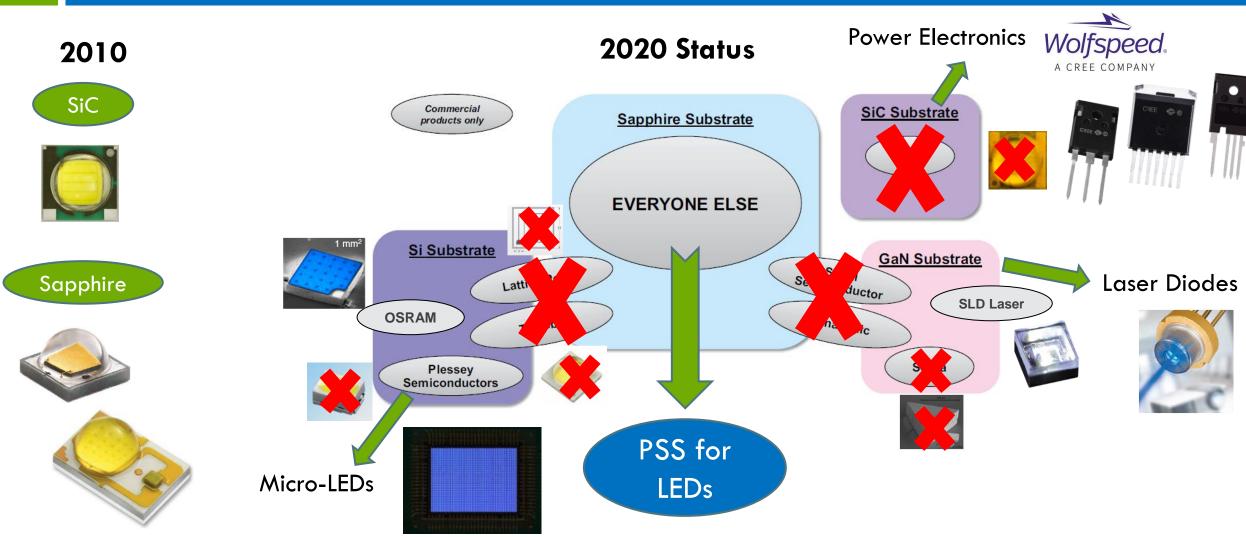






Evolution of Substrates





2010 \Rightarrow 2015: Package Designs



2010



MOCVD Government Subsidies from China Lead to Overcapacity (2010-2011)



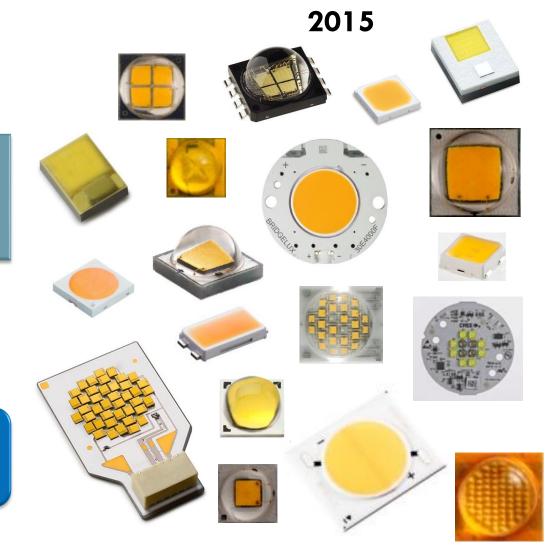
Mid-power packages pivot from TV backlighting to general lighting (2011-2012)



LED TV Backlight supply exceed market growth: Mid-Power LED Oversupply (2011)



LED Commoditization begins







2010 \Rightarrow 2015: Package Designs



2010



MOCVD Government Subsidies from China Lead to Overcapacity (2010-2011)

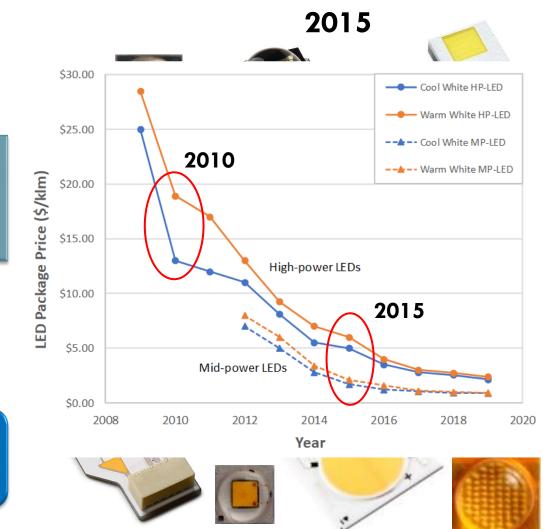


Mid-power packages pivot from TV backlighting to general lighting (2011-2012)

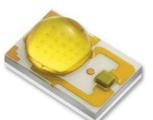




LED Commoditization begins



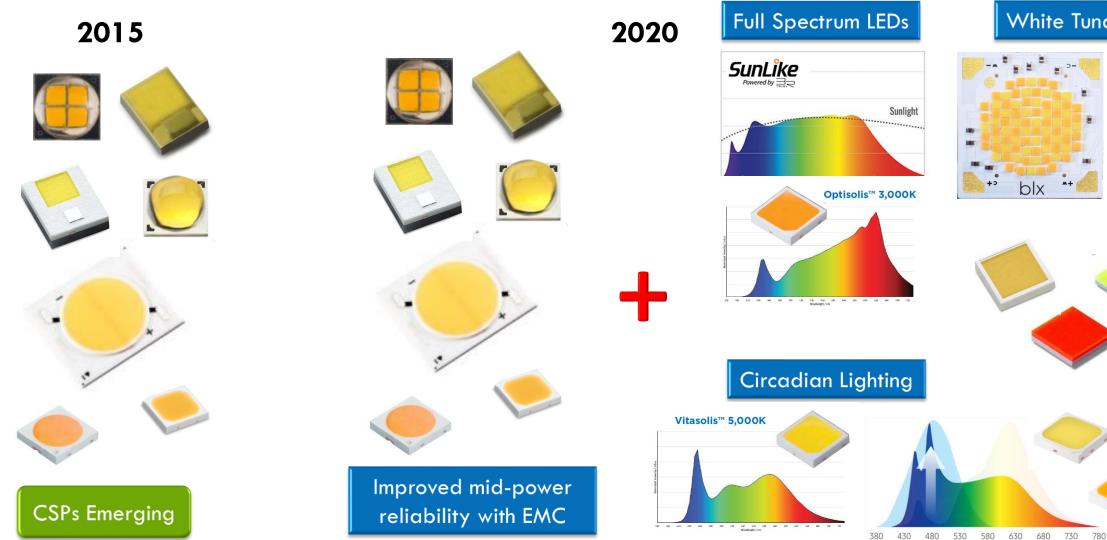


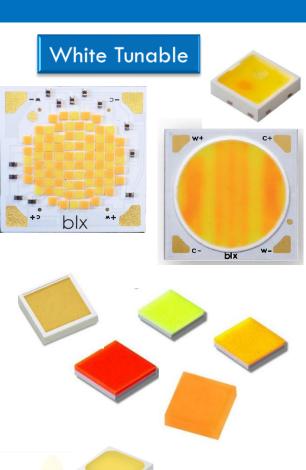




\Rightarrow 2020: Package Designs







2010 **2020**: Lamp Trends







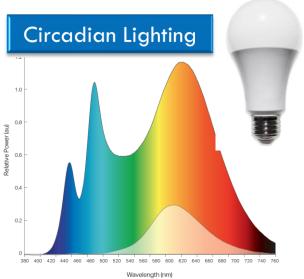








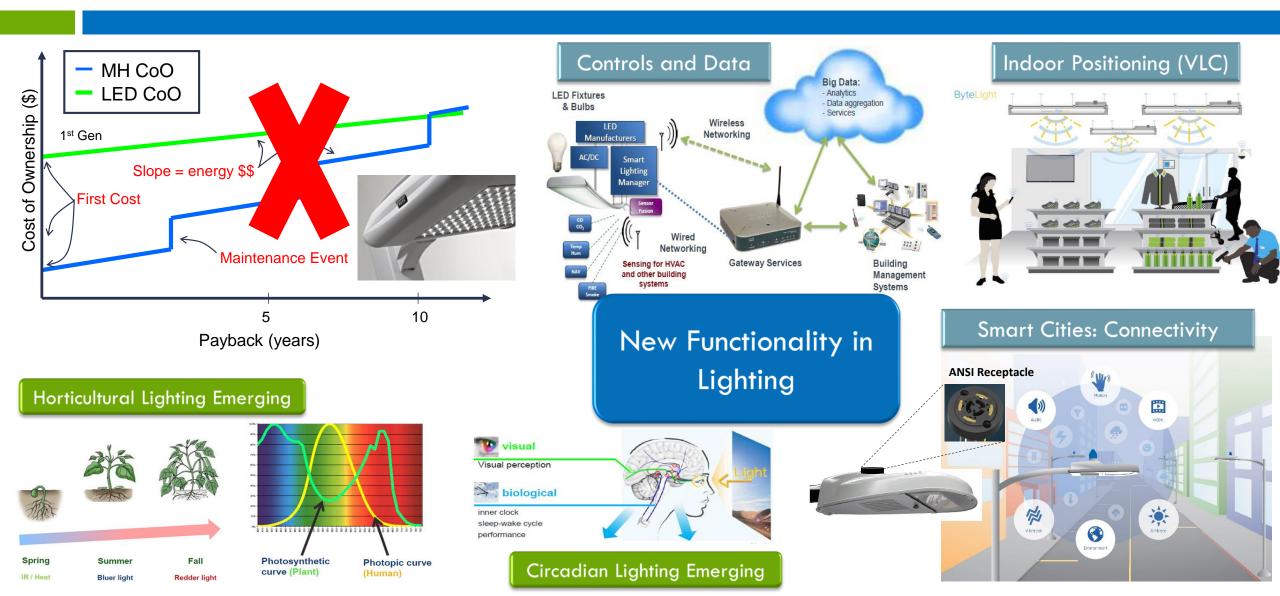




Full Output (3500K) Fully Dimmed (1900K)

\Rightarrow 2015: Luminaire Trends





2015 \Rightarrow 2020: Luminaire Trends



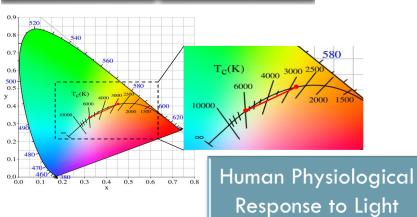
Dynamic Lighting



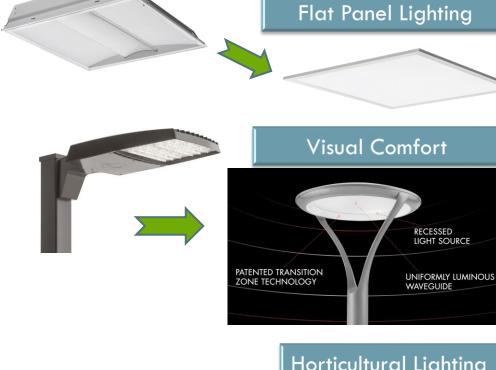


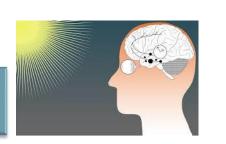






€ (€ 15 c**%)** Imax=1000mA at 85 C

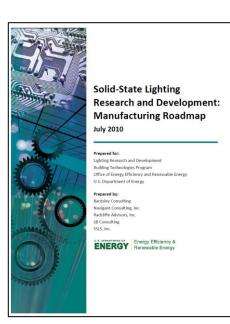






DOE Manufacturing Projects 2010-2012





2010 Manufacturing R&D Priority Tasks

Luminaire/Module Manufacturing

Driver Manufacturing

Test and Inspection Equipment

Tools for Epitaxial Growth

Wafer Processing Equipment

LED Packaging

Phosphor Manufacturing and Application

Veeco

KLA-Tencor Candela 8620 Wafer Inspection Tool

12 1

100000



Ultratech Sapphire 100 Stepper Tool



Veeco MaxBright
MOCVD Platform

Mfg Opportunity: Wafer Fab Automation













Cassette Loading

- MES (manufacturing execution system), tool-to-tool wafer movement, communication platforms, SPC control – no turn-key solutions for 150mm > leverage 200 mm silicon fab knowledge?
- Work is needed for 150 mm wafer fabs to improve factory automation to enable US manufacturing

- 150 mm
 compound-semi
 wafer fabs
 require labor to
 run the
 equipment.
- Manual loading or moving cassettes is still required

Mfg Opportunity: Wafer Fab Automation











150 mm compound-semi

Cree, NY State Form \$1B Partnership To Create World's Largest

Silicon Carbide Device Facility

More than 600 Cree jobs will be created at the Marcy Nanocenter on SUNY Poly Campus in collaboration with the New York Power Electronics Manufacturing Consortium.

abs

labor to

ent.

loading ng

- MES (manufacturing execution system), tool-to-tool wafer movement, communication platforms, SPC control – no turn-key solutions for 150mm | leverage 200 mm silicon fab knowledge?
- Work is needed for 150 mm wafer fabs to improve factory automation to enable US manufacturing

cassettes is still required

Mfg Opportunity: Automation for Luminaires



- Factory automation for assembly of LED lamps and some basic products such as small downlight has become common.
 - > Smaller variability in product designs and high volumes
 - > Lamps have more similar size scales of housings, drivers and optics parts
 - > Mechanics is a smaller part of lamp assembly compared to luminaires
- Automated luminaire assembly is not used assembly cells common
 - Huge dimension and performance SKU variability between products
 - Mechanics can be very difficult to automate
 (e.g. screws, pressure sensitive adhesives, wiring)



Opportunity: Design for Automated Manufacturing

Mfg Opportunity: Additive Manufacturing



Additive manufacturing benefits for lighting products:

- Fast, flexible, cost-effective prototyping
- Direct CAD to fabrication without tooling or inventory
- More product performance options:
 - Unique designs
 - High configurability ... low parts inventory



Interplay Lighting (Acuity Brands)

Challenges:

- Faster additive processing: increase print speeds, systems with larger print beds
- Develop new printable materials with improved optical, thermal, electrical properties
- Reduce or eliminate post-processing on printed parts

Mfg Opportunity: Sustainability



- Develop eco-friendly designs with lowembodied energy materials, recycled materials, or bioderived materials.
- Design for deconstruction to disassemble and recycle luminaire materials when the lighting is removed from the built environment.
- Provide materials transparency through certification bodies.







Manufacturing R&D Opportunities: 2021



- Factory Automation
 - Wafer Fab
 - Luminaire Assembly
- Reduce LED distribution
 - MOCVD uniformity
 - Phosphor deposition uniformity
- Additive Manufacturing
- Sustainable Materials

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